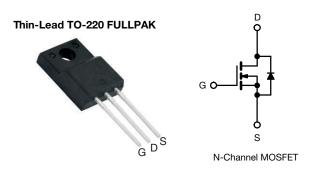
# SiHA11N80E

**Vishay Siliconix** 



# **E Series Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	850				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 0.38				
Q <sub>g</sub> max. (nC)	88				
Q <sub>gs</sub> (nC)	9				
Q <sub>gd</sub> (nC)	16				
Configuration	Single				

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION					
Package	Thin-lead TO-220 FULLPAK				
Lead (Pb)-free and halogen-free	SiHA11N80E-GE3				

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	800	V	
Gate-source voltage			V <sub>GS</sub>	± 30	V	
Continuous drain surrent (T 150 °C) a	V at 10 V	T <sub>C</sub> = 25 °C	– I <sub>D</sub>	12		
Continuous drain current ( $T_J = 150 \text{ °C}$ ) <sup>a</sup>	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		8	А	
Pulsed drain current <sup>b</sup>			I <sub>DM</sub>	32		
Linear derating factor				0.27	W/°C	
Single pulse avalanche energy <sup>c</sup>			E <sub>AS</sub>	226	mJ	
Maximum power dissipation			P <sub>D</sub>	34	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	T <sub>J</sub> = 125 °C		alı . / alt	70		
Reverse diode dv/dt <sup>d</sup>			dv/dt	4.3	V/ns	
Soldering recommendations (peak temperature) e	For 10 s			300	°C	
Mounting torque	M3 screw			0.6	Nm	

#### Notes

a. Limited by maximum junction temperature

b. Repetitive rating; pulse width limited by maximum junction temperature

c.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>q</sub> = 25  $\Omega$ , I<sub>AS</sub> = 4.0 A

d.  $I_{SD} \leq I_D$ , di/dt = 100 A/µs, starting T<sub>J</sub> = 25 °C

e. 1.6 mm from case

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP. MAX.		UNIT				
Maximum junction-to-ambient	R <sub>thJA</sub>	- 65			°C AN			
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 3.7				- °C/W		
<b>SPECIFICATIONS</b> ( $T_J = 25 \degree C$ , u	Inless otherwis	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNI
Static	•					•		
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 2	250 µA	800	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I <sub>D</sub> = 1 mA	-	1.1	-	V/°(
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	250 µA	2	-	4	V
			V <sub>GS</sub> = ± 20	V	-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 30	V	-	-	± 1	μA
		V <sub>DS</sub> =	= 800 V, V <sub>G</sub>	<sub>S</sub> = 0 V	-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 640 V	$V_{DS} = 640 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	۱ <sub>D</sub>	) = 5.5 A	-	0.38	0.44	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 5.5 A		-	4.5	-	S	
Dynamic	•					•		1
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1670	-	-	
Output capacitance	C <sub>oss</sub>			-	68	-		
Reverse transfer capacitance	C <sub>rss</sub>			-	9	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V		-	43	-	pF	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	212	-	1	
Total gate charge	Qg				-	44	88	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 5.5	A, V <sub>DS</sub> = 480 V	-	9	-	nC
Gate-drain charge	Q <sub>gd</sub>				-	16	-	
Turn-on delay time	t <sub>d(on)</sub>				-	18	36	
Rise time	t <sub>r</sub>	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 480 \; \text{V}, \; I_{\text{D}} = 5.5 \; \text{A}, \\ V_{\text{GS}} = 10 \; \text{V}, \; R_{\text{g}} = 9.1 \; \Omega \end{array}$		-	15	30	- ns	
Turn-off delay time	t <sub>d(off)</sub>			-	55	110		
Fall time	t <sub>f</sub>			-	18	36		
Gate input resistance	Rg	f = 1 MHz, open drain		0.4	0.9	1.8	Ω	
Drain-Source Body Diode Characteristi	•				•	•		
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	12		
Pulsed diode forward current	I <sub>SM</sub>			-	-	32	A	
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 5.5 A	, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 5.5 A,		-	345	690	ns	
Reverse recovery charge	Q <sub>rr</sub>			-	4.2	8.4	μ	
Reverse recovery current	I <sub>RRM</sub>		di/dt = 100 A/µs, V <sub>R</sub> = 25 V		-	21	-	A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS



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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

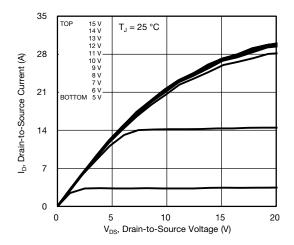
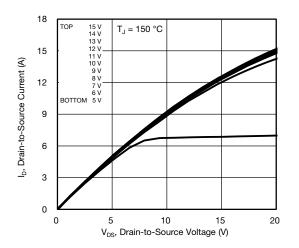
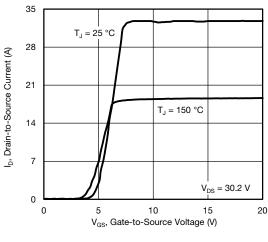


Fig. 1 - Typical Output Characteristics









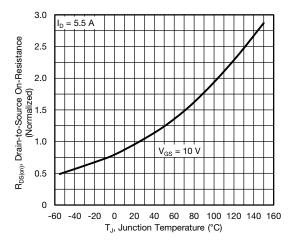


Fig. 4 - Normalized On-Resistance vs. Temperature

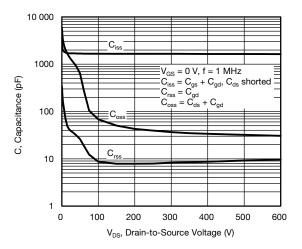


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

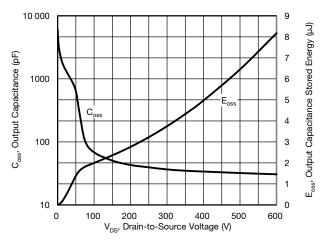


Fig. 6 -  $C_{\text{oss}}$  and  $E_{\text{oss}}$  vs.  $V_{\text{DS}}$ 

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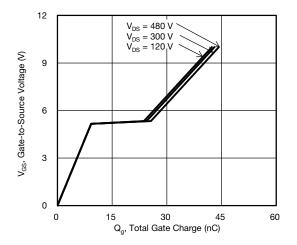


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

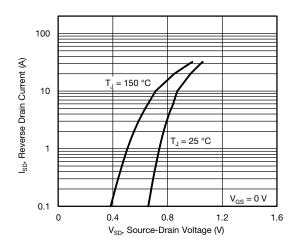


Fig. 8 - Typical Source-Drain Diode Forward Voltage

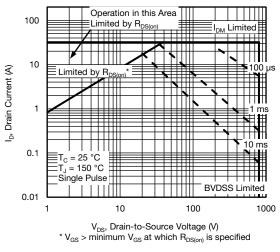


Fig. 9 - Maximum Safe Operating Area

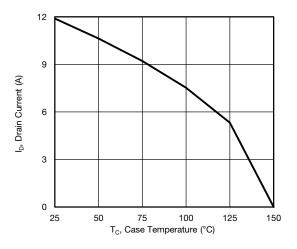


Fig. 10 - Maximum Drain Current vs. Case Temperature

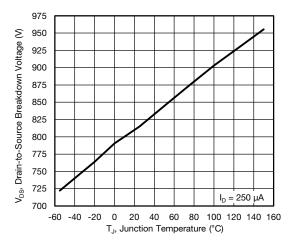
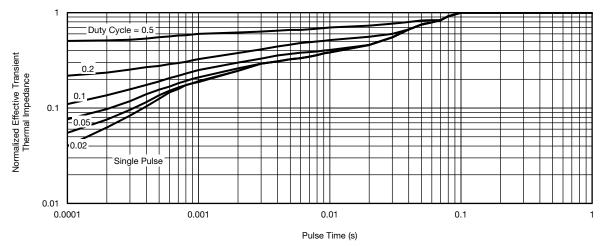


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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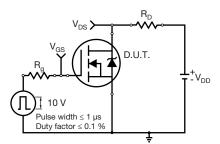


Fig. 13 - Switching Time Test Circuit

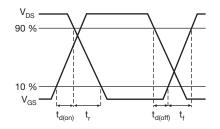


Fig. 14 - Switching Time Waveforms

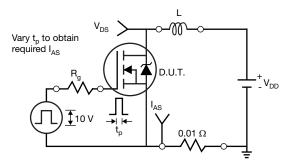


Fig. 15 - Unclamped Inductive Test Circuit

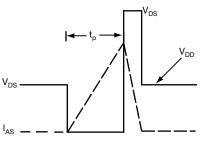


Fig. 16 - Unclamped Inductive Waveforms

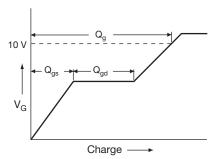


Fig. 17 - Basic Gate Charge Waveform

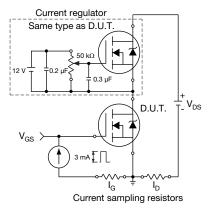


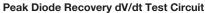
Fig. 18 - Gate Charge Test Circuit

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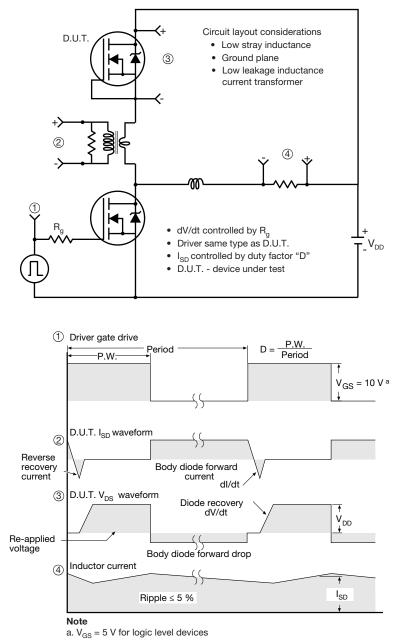


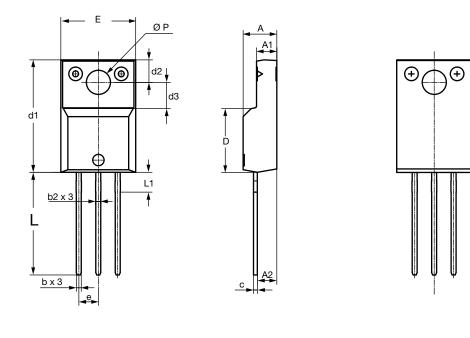
Fig. 19 - For N-Channel

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# **TO-220 FULLPAK Thin Lead**





	DIMENSIONS						
SYMBOL	MILLIN	METERS	INCHES				
	MIN.	MAX.	MIN.	MAX.			
А	4.30	4.70	0.169	0.185			
A1	2.50	2.90	0.098	0.114			
A2	2.40	2.80	0.094	0.110			
b	0.60	0.80	0.024	0.031			
b2	0.60	0.90	0.024	0.035			
С	-	0.60	-	0.024			
D	8.30	8.70	0.327	0.342			
d1	14.70	15.30	0.579	0.602			
d2	2.90	3.10	0.114	0.122			
d3	3.30	3.70	0.130	0.146			
E	9.70	10.30	0.382	0.406			
е	2.50	2.70	0.098	0.106			
L	13.40	13.80	0.528	0.543			
L1	1.00	2.80	0.039	0.110			
ØP	3.00	3.40	0.118	0.134			
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	•					

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